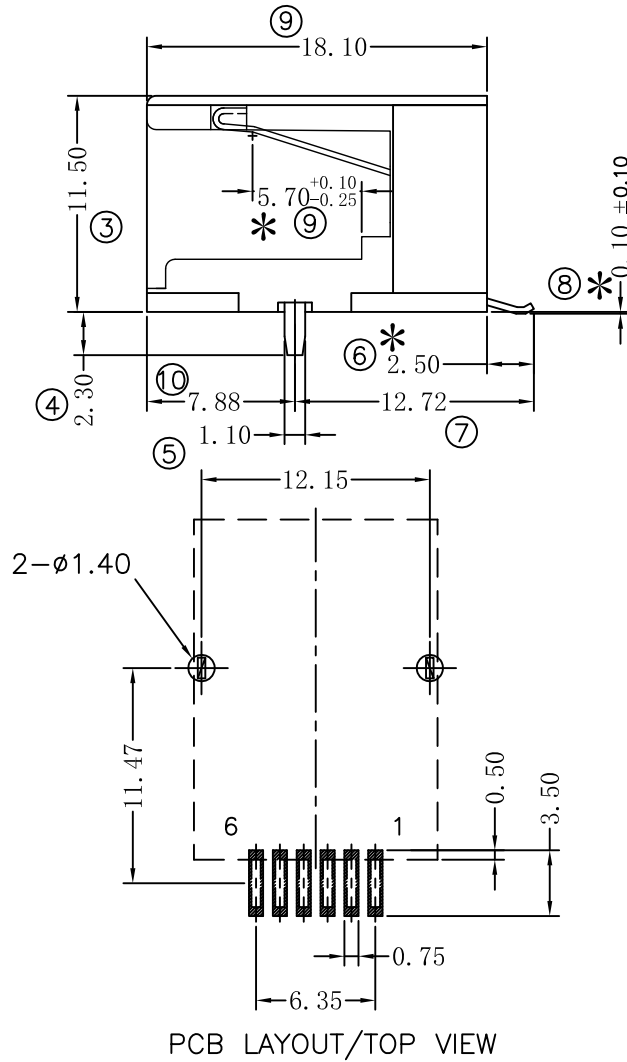
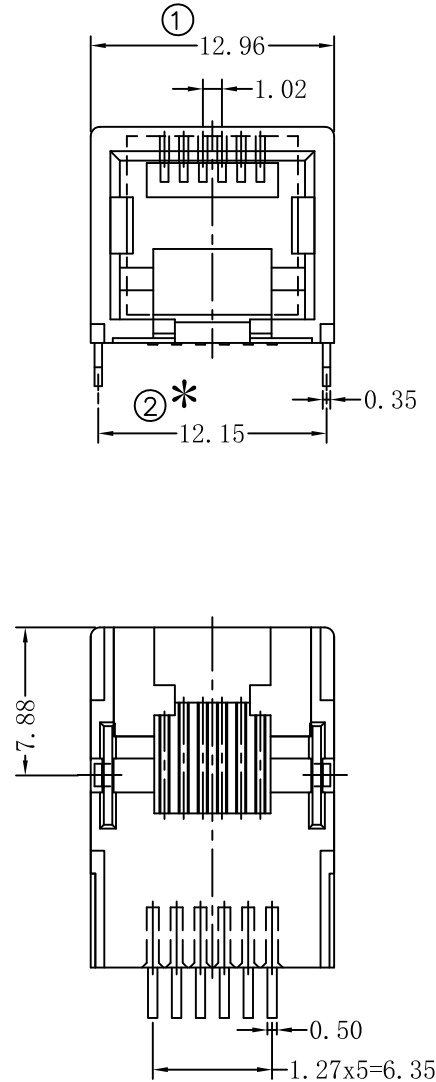


RoHS compliant



PCB LAYOUT/TOP VIEW

NOTES

MATERIAL

1. HOUSING MATERIAL : HIGH TEMP THERMOPLASTIC
FLAMMABILITY RATING UL94V-0.
2. CONTACT MATERIAL : PHOSPHOR BRONZE T=0.3mm.
3. PLATING : GOLD LATING OVER NICKEL IN CONTACT
TIN PLATING OVER NICKEL IN SOLDER AREA.
: FU", 3U", 6U", 15U", 30", 50".

ELECTRICAL

1. VOLTAGE RATING : 125 VAC RMS.
2. CURRENT RATING : 1.5 AMP.
3. CONTACT RESISTANCE : 40 MILLIOHMS MAX.
4. INSULATION RESISTANCE : 1000 MEGOHMS MIN @ 500V DC .
5. DIELECTRIC RESISTANCE : 1000V AC RMS 50Hz. 1MIN.

MECHANICAL

1. DURRABILITY : 750 CYCLES MIN.
2. PCB RETENTIONPRE-SOLDER : 1 LB MIN.

ENVIRONMENTAL:

1. STORAGE : -40°C ~ +85°C.
2. OPERATION : -20°C TO 75°C.

Mates With Modular Plug Conforming To FCC Part 68, Subpart F.

P/N:RJ56S-6611-030551X

56S RJ12 90° SMT SERIES PCB JACK

POSITIONS (金針位置):

6-POSITIONS(6P):

CONTACTS (金針根數):

6-CONTACTS (6C):

PORTS (窗口):

11-1X1

SHIELD (屏蔽壳):

0-Without SHIELD (无屏蔽壳)

IRON PEG (铁脚定位脚):

3-IRON Feet DIP (定位脚直插)

WORKING PEG (塑胶定位柱):

0-Without PEG (无定位柱)

PACKING TYPE (包装):

1-REEL (卷带包装)

2-PVC TRAY (盘装)

COLOR (颜色):

1-BLACK (黑色)

7-BLUE (蓝色)

PLASTIC (塑料):

4-LCP-5-PART

GOLD PLATING (镀金厚度):

1-1U":6-6U":6-15U":

7-30U":8-50U":

GENERAL TOLERANCE

.X ±0.35 X.° ±2°

.XX ±0.25 .X.° ±1°

.XXX ±0.15 .XX° ±0.5°

PROJECT

DRAWN

Gene Li

2019/11/21

CHECKE

HC

APPROVE

UNIT mm

SCALE 1:1

SHEET 1/1

X-SHUN

东莞市祥舜电子科技有限公司
DONGGUAN X-SHUN ELECTRONIC TECHNOLOGY CO., LTD

PART NO. RJ56S-6611-030551X

TITLE: RJ12 6P6C 90° L=18.1MM SMT PCB JACK

REV

A0

DRAWING NO.

RJ56S-66

REV

ECN NO

DESCRIPTION

DATE

SIGNATURE

PROJECT

UNIT mm

SCALE 1:1

SHEET 1/1

A0

NEW DESIGN

2019/11/21

PROJECT

UNIT mm

SCALE 1:1

SHEET 1/1

X-SHUN

东莞市祥舜电子科技有限公司
DONGGUAN X-SHUN ELECTRONIC TECHNOLOGY CO., LTD

PART NO. RJ56S-6611-030551X

TITLE: RJ12 6P6C 90° L=18.1MM SMT PCB JACK

REV

A0

DRAWING NO.

RJ56S-66